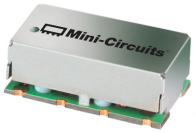
Surface Mount

Bandpass Filter

SXBP-2150+

50Ω 2050 to 2250 MHz



Generic photo used for illustration purposes only
CASE STYLE: HF1139

The Big Deal

- Fast roll-off on the upper sideband
- Good Matching and low loss in the pass band
- Miniature shielded package

Product Overview

SXBP-2150+ is a wideband bandpass filter in a miniature shielded package covering 2050 to 2250 MHz. This is designed for asymmetric rejection applications such as super-heterodyne receivers. By having asymmetric band, faster roll-off at upper side band is achieved in a comparatively smaller package and lower pass band insertion loss. It has repeatable performance across lots and consistent performance across temperature.

Key Features

Feature	Advantages
Fast roll-off on the upper side band	Wide bandwidth filter with fast-roll off on the upper side band, which increases selectivity on the adjacent channel.
Good matching and low loss in pass band	This filter has good matching and low loss in the pass band
Small size, 0.44" X 0.74" X 0.27"	The surface mount package enables the SXBP-2150+ to be used in compact designs.
High power handling	This model uses high Q capacitors and high current handling inductors which is well suited for high power applications.

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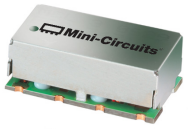
SXBP-2150+

50Ω 2050 to 2250 MHz



Generic photo used for illustration purposes only
CASE STYLE: HF1139

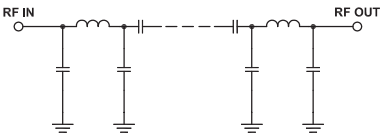
Features

- Wide bandwidth
- Better rejection
- Miniature shielded package

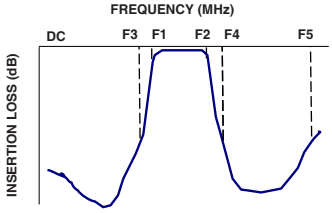
Applications

- Defense systems
- Fixed microwave
- IMT
- Auxiliary broadcasting
- Private and public land mobile

Functional Schematic



Typical Frequency Response



+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Electrical Specifications at 25°C

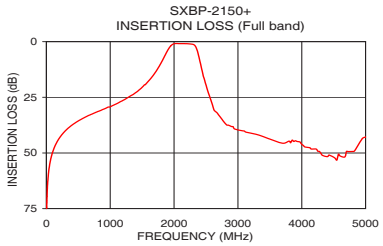
Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Center Frequency	-	-	-	2150	-	MHz
	Insertion Loss	F1-F2	2050-2250	-	1.0	2.0	dB
	VSWR	F1-F2	2050-2250	-	1.3	2.3	:1
Stop Band, Lower	Insertion Loss	DC-F3	DC-950	20.0	30.0	-	dB
	VSWR	DC-F3	DC-950	-	20.0	-	:1
Stop Band, Upper	Insertion Loss	F4-F5	2675-5000	20.0	31.0	-	dB
	VSWR	F4-F5	2675-5000	-	20.0	-	:1

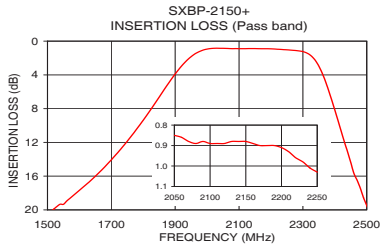
Maximum Ratings	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power Input	6.3 W max.

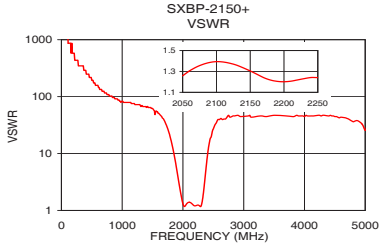
Permanent damage may occur if any of these limits are exceeded.

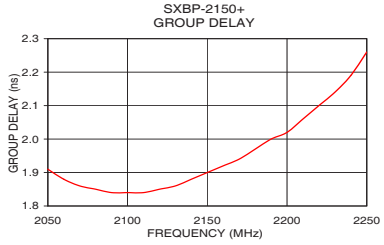
Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Group Delay (nsec)
1	89.17	1737.18	2050	1.91
100	49.46	1737.18	2070	1.86
250	41.53	434.30	2080	1.85
850	30.91	96.51	2090	1.84
950	29.63	86.86	2100	1.84
1490	20.77	62.05	2110	1.84
1800	9.37	17.75	2120	1.85
1900	3.90	5.09	2130	1.86
1960	1.56	2.10	2140	1.88
2050	0.85	1.26	2150	1.90
2150	0.88	1.30	2160	1.92
2250	1.03	1.24	2170	1.94
2320	1.57	1.49	2180	1.97
2360	3.75	3.43	2190	2.00
2400	8.15	8.55	2200	2.02
2525	21.93	31.60	2210	2.06
2675	32.02	40.41	2220	2.10
3100	40.13	46.96	2230	2.14
4300	50.15	46.96	2240	2.19
5000	42.88	25.56	2250	2.26







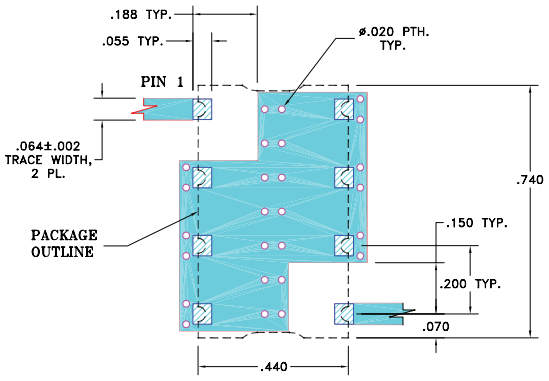


Notes
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Pad Connections

INPUT	1
OUTPUT	8
GROUND	2,3,4,5,6,7

Demo Board MCL P/N: TB-368+
Suggested PCB Layout (PL-230)



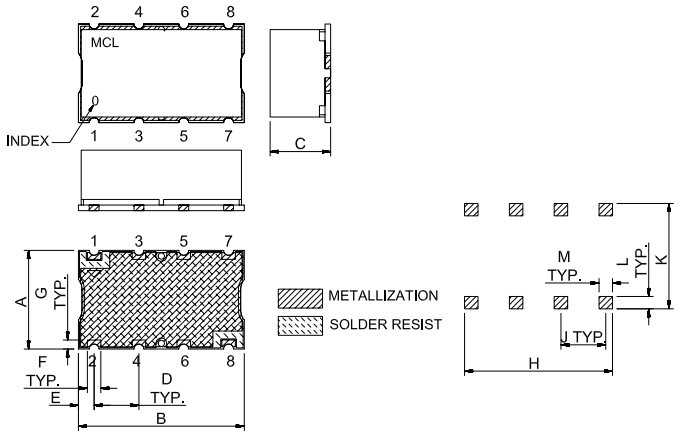
NOTE:

1. TRACE WIDTH IS SHOWN FOR FR4 WITH DIELECTRIC THICKNESS: .025"±.002". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Outline Drawing



Outline Dimensions (inch / mm)

A	B	C	D	E	F	G
.44	.74	.27	.200	.07	.060	.040
11.18	18.80	6.86	5.08	1.78	1.52	1.02
H	J	K	L	M		wt
.660	.200	.470	.055	.060		grams
16.76	5.08	11.94	1.40	1.52		3.0

Note: Please refer to case style drawing for details

Band Pass Filter SXBP-2150+

Typical Performance Data

FREQ.	INSERTION LOSS			INPUT RETURN LOSS			OUTPUT RETURN LOSS		
(MHz)	(dB)			(dB)			(dB)		
	@-40℃	@+25˚C	@+85˚C	@-40℃	@+25˚C	@+85˚C	@-40℃	@+25˚C	@+85˚C
1	88.76	89.17	88.45	0.01	0.01	0.01	0.00	0.00	0.00
25	61.58	61.61	61.47	0.01	0.01	0.01	0.01	0.01	0.00
90	50.47	50.38	50.28	0.01	0.01	0.01	0.01	0.01	0.01
120	47.98	47.86	47.73	0.01	0.02	0.02	0.01	0.02	0.02
170	45.01	44.86	44.72	0.01	0.02	0.03	0.01	0.02	0.02
210	43.13	43.03	42.88	0.02	0.03	0.04	0.02	0.03	0.04
300	39.92	39.96	39.91	0.03	0.05	0.05	0.03	0.04	0.05
400	37.39	37.49	37.55	0.04	0.06	0.07	0.04	0.07	0.07
500	35.54	35.61	35.67	0.07	0.09	0.10	0.07	0.09	0.10
520	35.21	35.27	35.34	0.07	0.09	0.10	0.07	0.10	0.11
600	33.99	34.03	34.09	0.09	0.11	0.13	0.09	0.12	0.13
700	32.66	32.68	32.74	0.12	0.14	0.16	0.12	0.15	0.17
800	31.45	31.46	31.54	0.14	0.17	0.18	0.14	0.18	0.19
900	30.27	30.29	30.34	0.16	0.19	0.21	0.17	0.21	0.22
950	29.61	29.63	29.66	0.17	0.20	0.22	0.17	0.21	0.23
1000	29.22	29.25	29.27	0.18	0.21	0.23	0.18	0.23	0.24
1280	25.02	25.04	24.96	0.20	0.24	0.27	0.21	0.26	0.28
1400	22.94	22.86	22.76	0.21	0.27	0.29	0.22	0.28	0.30
1520	20.01	19.90	19.78	0.23	0.30	0.33	0.24	0.30	0.34
1600	17.82	17.68	17.54	0.26	0.34	0.38	0.27	0.34	0.38
1700	14.24	14.07	13.93	0.38	0.47	0.53	0.38	0.48	0.54
1770	11.05	10.90	10.79	0.63	0.75	0.82	0.63	0.75	0.83
1810	8.96	8.84	8.74	0.93	1.08	1.18	0.92	1.07	1.16
1880	4.99	4.95	4.90	2.34	2.58	2.75	2.25	2.48	2.64
1900	3.92	3.90	3.88	3.17	3.46	3.67	3.05	3.32	3.52
1920	2.94	2.95	2.95	4.38	4.74	4.99	4.19	4.51	4.74
1960	1.47	1.56	1.61	8.50	9.02	9.42	7.99	8.40	8.73
2000	0.80	0.94	1.02	16.73	17.43	18.16	14.27	14.56	14.90
2020	0.71	0.85	0.94	21.65	21.94	22.44	16.92	16.95	17.10
2050	0.70	0.85	0.94	18.74	18.83	18.69	16.48	16.57	16.48
2150	0.73	0.88	0.98	17.08	17.57	17.60	17.90	18.62	18.71
2180	0.74	0.90	1.00	19.73	20.17	20.31	22.21	23.11	23.32
2200	0.75	0.91	1.02	20.39	20.78	21.07	24.02	24.82	25.37
2250	0.85	1.03	1.15	18.47	19.37	20.05	19.85	21.04	22.05
2290	0.95	1.17	1.32	21.42	22.32	22.04	25.52	31.37	35.52
2320	1.24	1.57	1.82	15.69	14.07	13.03	17.70	15.72	14.54
2350	2.42	2.96	3.35	7.41	6.76	6.33	7.88	7.24	6.82
2390	6.24	6.94	7.46	2.59	2.51	2.44	2.76	2.71	2.67
2430	11.29	11.94	12.46	1.13	1.20	1.23	1.22	1.31	1.34
2500	18.85	19.48	20.08	0.58	0.64	0.67	0.60	0.72	0.79
2550	23.65	24.06	24.57	0.40	0.50	0.55	0.48	0.58	0.64
2625	29.98	30.64	30.89	0.35	0.42	0.49	0.35	0.45	0.51
2675	31.70	32.02	32.26	0.33	0.43	0.48	0.36	0.46	0.52
2975	41.44	42.05	43.17	0.29	0.40	0.46	0.26	0.36	0.43
3000	38.58	38.55	40.39	0.30	0.40	0.48	0.24	0.35	0.43
3100	40.20	40.13	39.99	0.27	0.37	0.43	0.25	0.36	0.43
3175	38.74	38.60	40.70	0.27	0.38	0.48	0.28	0.39	0.47
3375	42.68	42.42	41.63	0.29	0.39	0.44	0.29	0.41	0.49
3525	43.14	42.59	41.88	0.28	0.38	0.43	0.31	0.41	0.47
3700	45.82	45.62	44.38	0.28	0.38	0.44	0.29	0.40	0.46
3750	43.11	43.21	42.98	0.29	0.39	0.44	0.30	0.41	0.46
4000	47.03	46.13	44.47	0.28	0.39	0.43	0.31	0.42	0.47
4050	46.98	47.29	46.57	0.27	0.38	0.43	0.31	0.42	0.47
4150	49.16	48.24	47.91	0.27	0.38	0.43	0.30	0.40	0.46
4300	50.52	50.15	52.77	0.26	0.37	0.42	0.30	0.40	0.46
4525	51.74	52.42	51.43	0.28	0.39	0.44	0.29	0.40	0.46
4625	48.98	48.70	49.30	0.31	0.43	0.48	0.28	0.39	0.45
4825	48.29	49.12	55.39	0.35	0.47	0.56	0.30	0.41	0.48
4975	40.83	40.69	39.30	0.44	0.55	0.63	0.31	0.43	0.52
5000	44.19	42.88	42.61	0.53	0.68	0.66	0.36	0.48	0.53

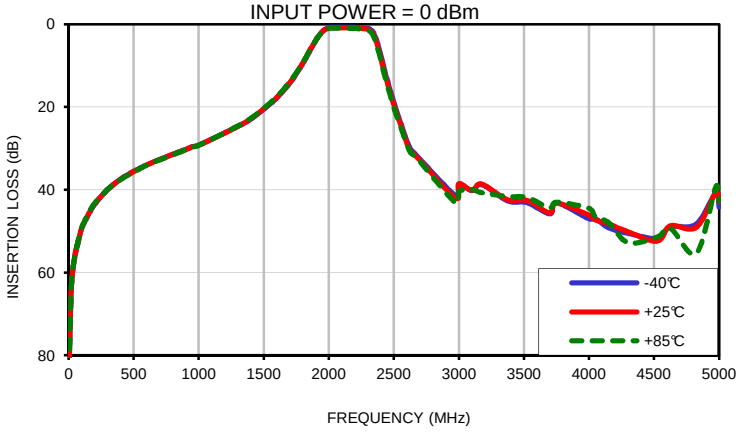
Typical Performance Data

FREQ.	GROUP DELAY		
(MHz)	(nsec)		
	@-40℃	@+25˚C	@+85˚C
2050	5.20	5.16	5.12
2060	5.16	5.14	5.09
2070	5.14	5.11	5.07
2080	5.11	5.08	5.03
2090	5.08	5.06	5.01
2100	5.06	5.03	4.99
2110	5.03	5.01	4.96
2120	5.00	4.98	4.94
2130	4.98	4.96	4.92
2140	4.96	4.94	4.90
2150	4.94	4.92	4.88
2160	4.91	4.89	4.86
2170	4.89	4.87	4.84
2180	4.87	4.85	4.82
2190	4.85	4.83	4.80
2200	4.83	4.81	4.78
2210	4.81	4.80	4.76
2220	4.79	4.78	4.74
2230	4.78	4.76	4.73
2240	4.76	4.74	4.71
2250	4.74	4.73	4.70

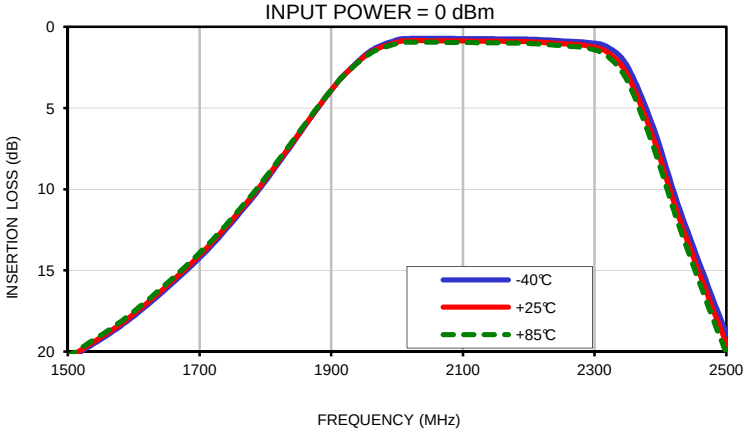
Band Pass Filter SXBP-2150+

Typical Performance Curves

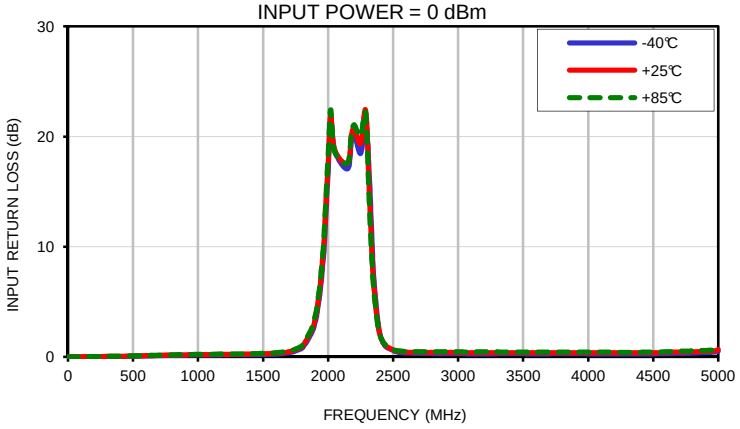
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



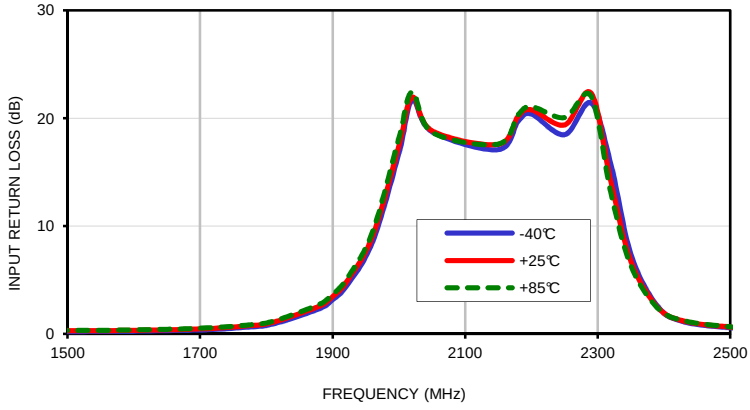
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



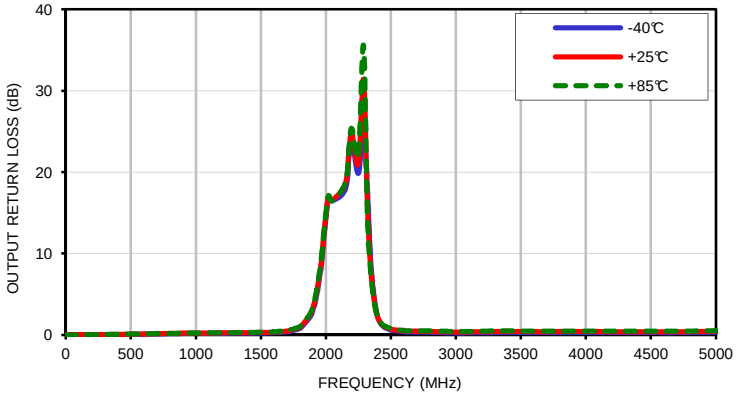
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



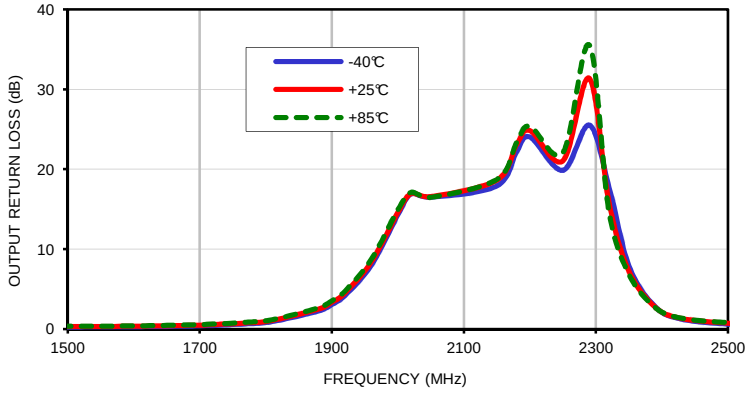
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



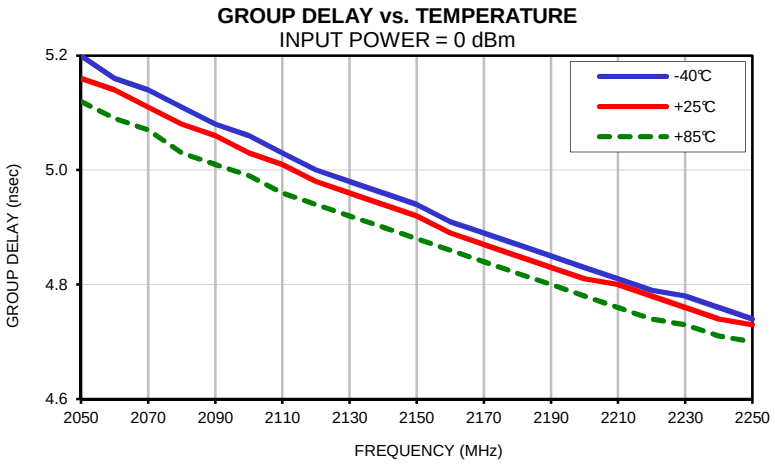
OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



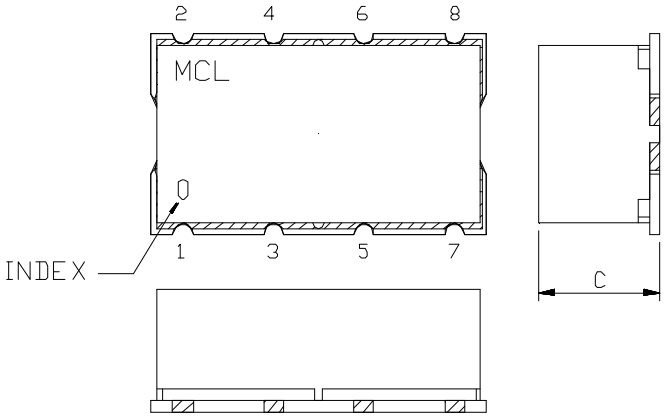
Typical Performance Curves

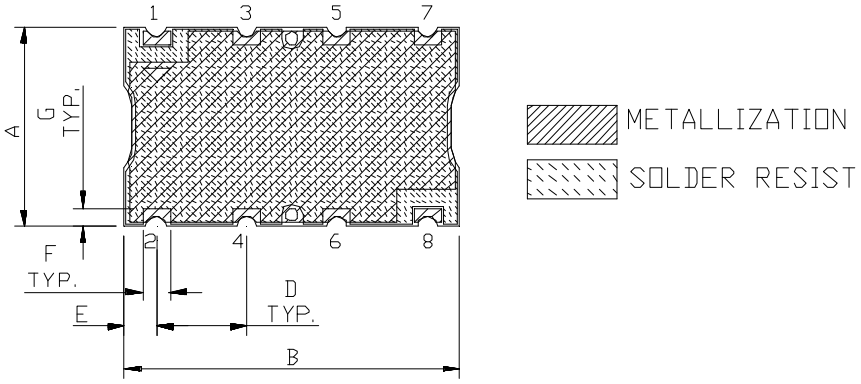


Case Style HF

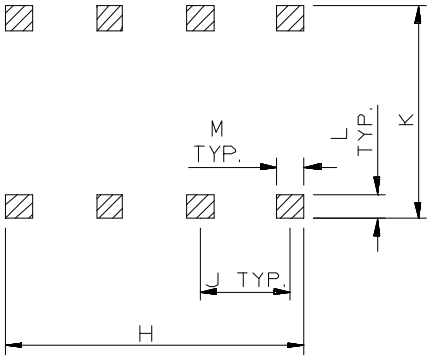
HF1139

Outline Dimensions





PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
HF1139	.44 (11.18)	.74 (18.80)	.27 (6.86)	.200 (5.08)	.07 (1.78)	.060 (1.52)	.040 (1.02)	.660 (16.76)	.200 (5.08)	.470 (11.94)	.055 (1.40)	.060 (1.52)	3.0

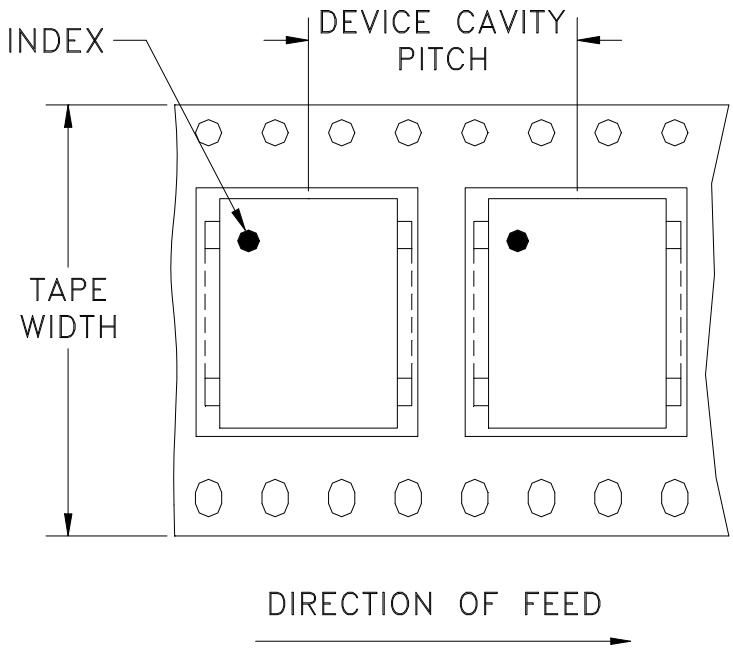
Dimensions are in inches (mm). Tolerances: 2 Pl. ±.015"; 3 Pl. ±.01"

Notes:

1. Case material: Nickel-Silver alloy.
2. Base: Printed wiring laminate.
3. Termination finish:
   For RoHS Case Styles: 2-5 µ inch (.05-.13 microns) Gold over 120-240 µ inch (3.05-6.10 microns) Nickel plate.
   For RoHS-5 Case Styles: Tin-Lead plate.

Tape & Reel Packaging TR-F5

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
32	16	13	500

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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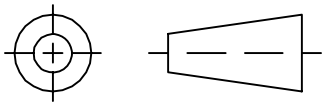
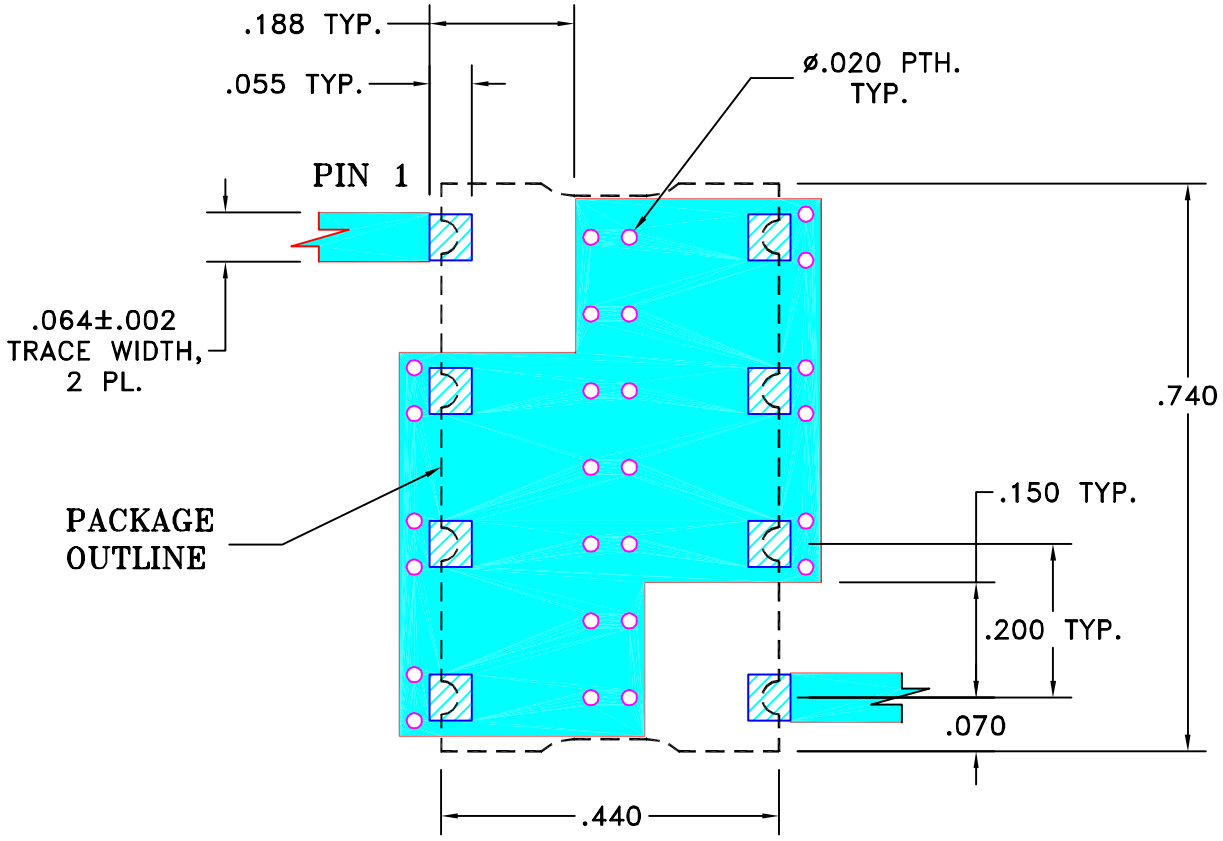
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M101757	NEW RELEASE (FROM RAVON)	11/05	DK	HH
OR	R62293	NEW RELEASE (FROM RAVON)	11/05	DK	HH

SUGGESTED MOUNTING CONFIGURATION
FOR HF1139 CASE STYLE, cr PIN CONNECTION, 50 OHM.



NOTE:

1. TRACE WIDTH IS SHOWN FOR FR4 WITH DIELECTRIC THICKNESS: .025"±.002". COPPER: 1/2 OZ. EACH SIDE.
   FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	DK (RAVON)	29 NOV 05
TOLERANCES ON:	CHECKED	RZ (RAVON)	29 NOV 05
2 PL DECIMALS ±	APPROVED	HH (RAVON)	29 NOV 05
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

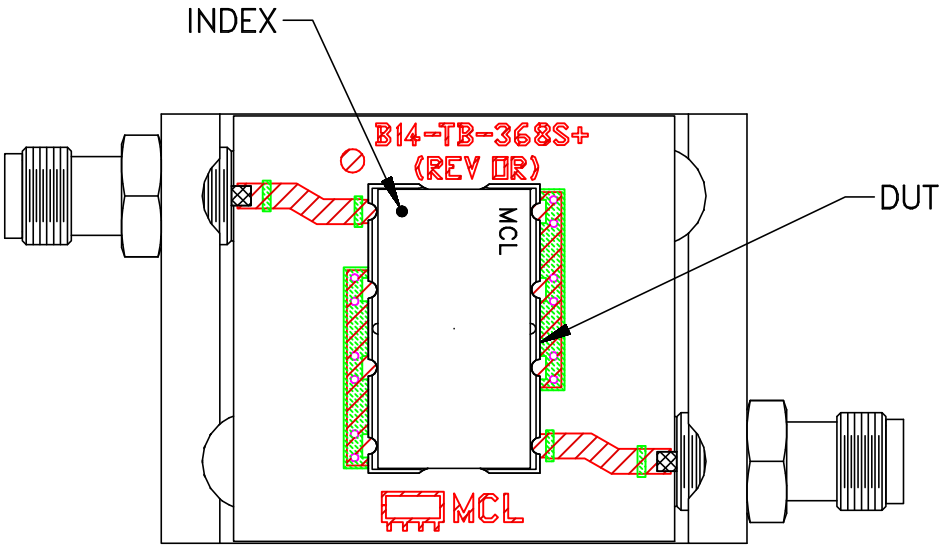
ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

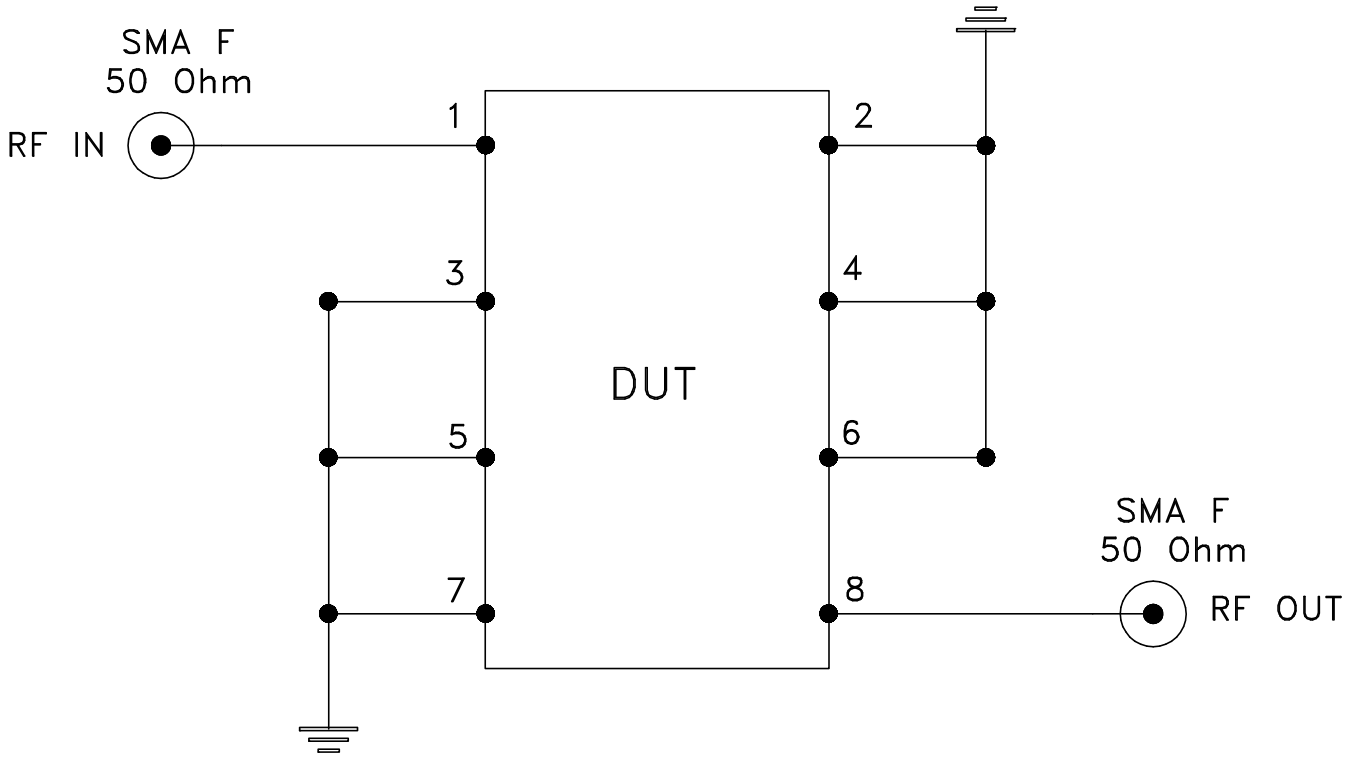
PL, cr, HF1139, SCLF, TB-368

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-230	OR
FILE: 98PL230	SCALE: 4:1	SHEET: 1 OF 1	

Evaluation Board and Circuit



TB-368



Schematic Diagram

Notes:
1. SMA Female connectors.
2. PCB Material: ROGERS R04350B or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

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Environmental Specifications ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215